

## Drift

Drift is the motion of charge carriers caused by an electric field. This means the voltage is applied to a semiconductor material.

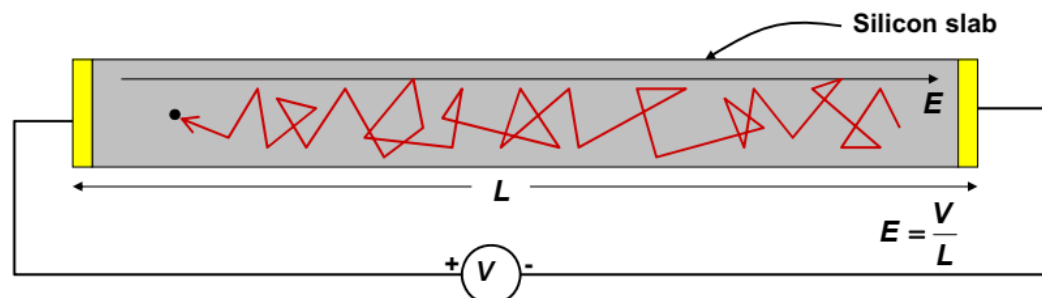
**Note:** The drift velocity is so much more important than the thermal velocity in semiconductor devices. A faster carrier velocity is desirable, for it allows a semiconductor device or circuit to operate at a higher speed.

## Mobility of carriers

When an **electric field** is applied to the semiconductor, both the free electrons (residing in the conduction band) and the holes (left behind in the valence band) move through the crystal, producing an electric current. The electrical conductivity of a material depends on the number of free electrons and holes (charge carriers) per unit volume and the mobility of carriers. *Mobility is the parameter that determines how fast a carrier, i.e., electron or hole, can move in a solid material under an applied electric field.* It is limited by collisions of electrons and holes with other carriers, with crystal defects, and with phonons (lattice vibrations). These scattering events slow down the carriers and constitute the electrical resistance of the material.

### **A. Electron mobility**

Figure 16 shows the motion of electrons in Si material under an applied electric field. The electron moves in the direction opposite to the applied field with a constant drift velocity equal to  $v_{dn}$ .



**Figure 16.**

The electron drift velocity  $v_{dn}$  is proportional to the electric field

$$v_{dn} \propto -E$$

$$\text{So, } v_{dn} = -\mu_n E \dots\dots\dots (1)$$

The force on the electron because of the electric field ( $E$ ) is

$$F_{ext} = -qE \dots\dots\dots (2)$$

where  $q$  is an electron charge ( $= 1.6 \times 10^{-19}$  C).

$$\text{The acceleration of electron, } a = \frac{F_{ext}}{m_n^*} \dots\dots\dots (3)$$

Substitute eq.(2) in eq.(3), we get:

$$a = -\frac{q E}{m_n^*} \dots\dots\dots (4)$$

The average drift velocity of the electron is

$$v_{dn} = a \tau_n \dots\dots\dots (5)$$

where  $\tau_n$  is the mean time between collisions (scattering time of electrons).

Substitute eq.(4) in eq.(5), we get:

$$v_{dn} = -\frac{q \tau_n}{m_n^*} E \dots\dots\dots (6)$$

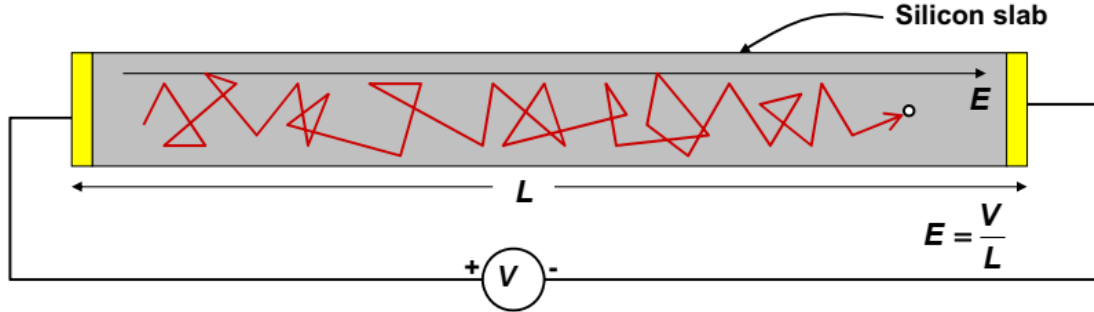
Comparing eq.(1) with eq.(6), we get:

$$\mu_n = \frac{q \tau_n}{m_n^*} \dots\dots\dots (7)$$

The constant  $\mu_n$  is called **electron mobility**, which its unit is :  $\frac{\text{m}^2}{\text{V.s}}$ . For example, the electron mobility of pure silicon is  $\approx 1350 \frac{\text{cm}^2}{\text{V.s}}$ .

## B. Hole mobility

Figure 17 shows the motion of holes in Si material under an applied electric field. The hole moves in the direction of the applied field with a constant drift velocity equal to  $v_{dp}$ .



**Figure 17.**

The hole drift velocity  $v_{dp}$  is proportional to the electric field

$$v_{dp} \propto E$$

$$\text{So, } v_{dp} = \mu_p E$$

The force on the hole because of the electric field ( $E$ ) is

$$F_{ext} = qE$$

Similarly, for holes, **hole mobility** is

$$\mu_p = \frac{q \tau_p}{m_p^*} \dots \dots \dots (8)$$

where  $\tau_p$  is the mean scattering time of holes. For example, the hole mobility of pure silicon is  $\approx 450 \frac{\text{cm}^2}{\text{V.s}}$ .

**Example:** Consider the electron mobility of pure Si is  $1350 \text{ cm}^2.\text{V}^{-1}.\text{s}^{-1}$  and  $\mu_p$  is  $450 \text{ cm}^2.\text{V}^{-1}.\text{s}^{-1}$ . The effective masses are  $m_n^*$  is  $0.26m_e$  and  $m_p^*$  is  $0.38m_e$ . Find the scattering time for electrons and holes.

**Solution:**

For electrons,

$$\mu_n = \frac{q \tau_n}{m_n^*}$$

$$\tau_n = \frac{\mu_n m_n^*}{q} = \frac{(0.135) \times (0.26 \times 9.1 \times 10^{-31})}{1.6 \times 10^{-19}} = 2 \times 10^{-13} \text{ s}$$

For holes,

$$\mu_p = \frac{q \tau_p}{m_p^*}$$

$$\tau_p = \frac{\mu_p m_p^*}{q} = \frac{(0.045) \times (0.38 \times 9.1 \times 10^{-31})}{1.6 \times 10^{-19}} = 1 \times 10^{-13} \text{ s}$$